

**650V N-Channel Enhancement Mode Power IGBT**

**MAIN CHARACTERISTICS**

<b>I<sub>c</sub> @TC=100°C</b>	6A
<b>V<sub>CE</sub></b>	650V
<b>VCE(sat)-typ</b>	1.7V

**FEATURES**

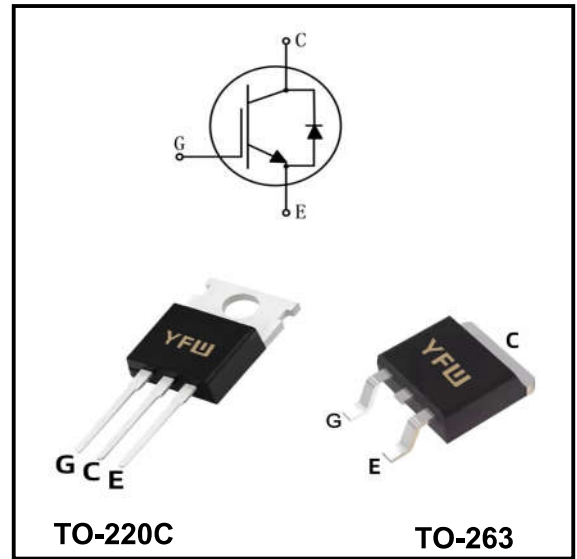
- ◆ High ruggedness performance
- ◆ Very tight parameter distribution
- ◆ Positive VCE (sat) temperature coefficient
- ◆ High efficiency for motor control
- ◆ Excellent current sharing in parallel operation
- ◆ RoHS compliant.

**APPLICATIONS**

- ◆ Home appliances
- ◆ Motor drives
- ◆ Fan, Pumps, Vacuum cleaner

**MECHANICAL DATA**

- ◆ Case: Molded plastic
- ◆ Mounting Position: Any
- ◆ Molded Plastic: UL Flammability Classification Rating 94V-0
- ◆ Lead free in compliance with EU RoHS 2011/65/EU directive
- ◆ Solder bath temperature 275°C maximum, 10s per JESD 22-B106



**Maximum Ratings**

Characteristics	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CEs</sub>	650	V
Gate-emitter voltage	V <sub>GES</sub>	±20	V
Continuous collector current (TC=25°C)	I <sub>c</sub>	12	A
Continuous collector current (TC=100°C)		6	A
Pulsed collector current, tp limited by Tvjmax	I <sub>CM</sub>	24	A
Diode continuous forward current (TC=100°C)	I <sub>F</sub>	6	A
Diode maximum current, tp limited by Tvjmax	I <sub>FM</sub>	24	A
Short circuit withstand time	t <sub>sc</sub>	10	µs
Power dissipation (TC=25°C)	P <sub>tot</sub>	136	W
Power dissipation (TC=100°C)		68	W
Operating junction temperature range	T <sub>vj</sub>	-40 to +175	°C
Storage temperature range	T <sub>stg</sub>	-40 to +150	°C

**Thermal characteristics**

Characteristics	Symbol	Values		Unit
		Typ	Max.	
Thermal resistance, junction to case for IGBT	$R_{th(j-c)}$	-	1.1	K/ W
Thermal resistance, junction to case for Diode	$R_{th(j-c)}$	-	4	K/ W
Thermal resistance, junction to ambient	$R_{th(j-a)}$	-	90	K/ W

 Note1:Pulse test: 300  $\mu$ s pulse width, 2 % duty cycle

**Electrical characteristics of IGBT at  $T_{vj}=25^{\circ}\text{C}$  unless otherwise specified**

Characteristics	Test Condition	Symbol	Min	Typ	Max	Unit	
Collector-emitter breakdown voltage	$V_{GE}=0V, I_c=250\mu A$	<b>BVCES</b>	650	-	-	<b>V</b>	
Collector-emitter leakage current	$V_{CE}=650V, V_{GE}=0V$	<b>ICES</b>	-	-	10	$\mu$ <b>A</b>	
Gate leakage current, forward	$V_{GE}=\pm 20V, V_{CE}=0V$	<b>IGES</b>	-	-	$\pm 100$	<b>nA</b>	
Gate-emitter threshold voltage	$V_{GE}=V_{CE}, I_c=1mA$	<b>VGE(th)</b>	5.2	6.2	7.2	<b>V</b>	
Collector-emitter saturation voltage	$V_{GE}=15V, I_c=6A$	<b>VCE(sat)</b>	-	1.7	-	<b>V</b>	
	$V_{GE}=15V, I_c=6A, T_{vj}=175$		-	2.2	-	<b>V</b>	
Input capacitance	$V_{CE}=30V$	<b>Cies</b>	-	480	-	<b>pF</b>	
Output capacitance	$V_{GE}=0V$	<b>Coes</b>	-	22	-	<b>pF</b>	
Reverse transfer capacitance	$f=1MHz$	<b>Cres</b>	-	8	-	<b>pF</b>	
Total gate charge	$V_{CC}=520V, V_{GE}=15V, I_c=6A$	<b>Qg</b>	-	19	-	<b>nC</b>	
Turn-on delay time	$V_{CC}=400V$ $V_{GE}=15V$ $I_c=6A$ $R_G=10\Omega$ Inductive load	<b>td(on)</b>	-	10	-	<b>ns</b>	
Rise time		<b>tr</b>	-	8	-	<b>ns</b>	
Turn-off delay time		<b>td(off)</b>	-	79	-	<b>ns</b>	
Fall time		<b>tf</b>	-	56	-	<b>ns</b>	
Turn-on energy		<b>Eon</b>	-	0.11	-	<b>mJ</b>	
Turn-off energy		<b>Eoff</b>	-	0.1	-	<b>mJ</b>	
Total switching energy		<b>Ets</b>	-	0.21	-	<b>mJ</b>	
Turn-on delay time		$V_{CC}=400V$ $V_{GE}=15V$ $I_c=6A$ $R_G=10\Omega$ Inductive load $T_{vj}=175^{\circ}\text{C}$	<b>td(on)</b>	-	11	-	<b>ns</b>
Rise time			<b>tr</b>	-	10	-	<b>ns</b>
Turn-off delay time			<b>td(off)</b>	-	108	-	<b>ns</b>
Fall time	<b>tf</b>		-	89	-	<b>ns</b>	
Turn-on energy	<b>Eon</b>		-	0.16	-	<b>mJ</b>	
Turn-off energy	<b>Eoff</b>		-	0.16	-	<b>mJ</b>	
Total switching energy	<b>Ets</b>		-	0.32	-	<b>mJ</b>	
Diode forward voltage	$I_F=6A$		<b>VF</b>	-	1.6	-	<b>V</b>
	$I_F=6A, T_{vj}=175^{\circ}\text{C}$	-		1.4	-	<b>V</b>	
Diode reverse recovery time	$V_R=400V$ $I_F=6A$	<b>trr</b>	-	55	-	<b>ns</b>	
Diode peak reverse recovery current	$diF/dt=-500A/\mu s$	<b>Irrm</b>	-	10	-	<b>A</b>	
Diode reverse recovery charge		<b>Qrr</b>	-	306	-	<b>nC</b>	
Diode reverse recovery time	$V_R=400V$ $I_F=6A$	<b>trr</b>	-	98	-	<b>ns</b>	
Diode peak reverse recovery current	$diF/dt=-500A/\mu s, T_{vj}=175^{\circ}\text{C}$	<b>Irrm</b>	-	12	-	<b>A</b>	
Diode reverse recovery charge		<b>Qrr</b>	-	529	-	<b>nC</b>	

RATINGS AND CHARACTERISTIC CURVES

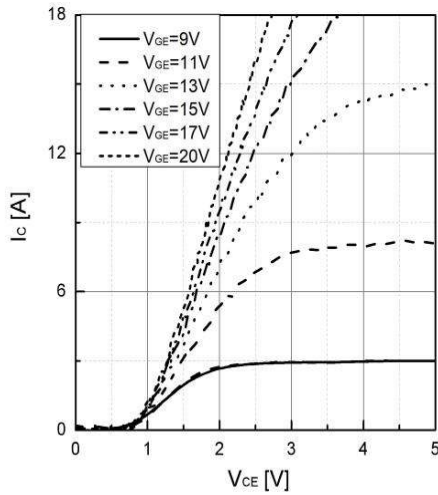


Fig 1. Typical output characteristic ( $T_{vj}=25^{\circ}\text{C}$ )

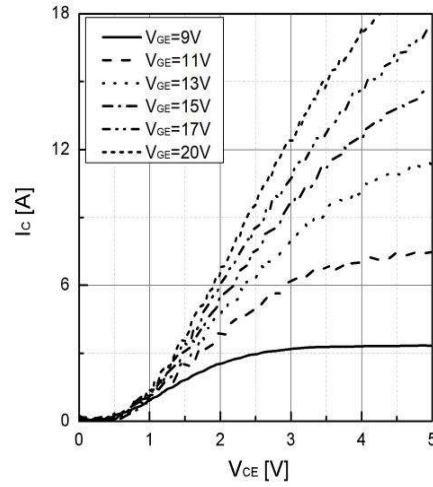


Fig 2. Typical output characteristic ( $T_{vj}=175^{\circ}\text{C}$ )

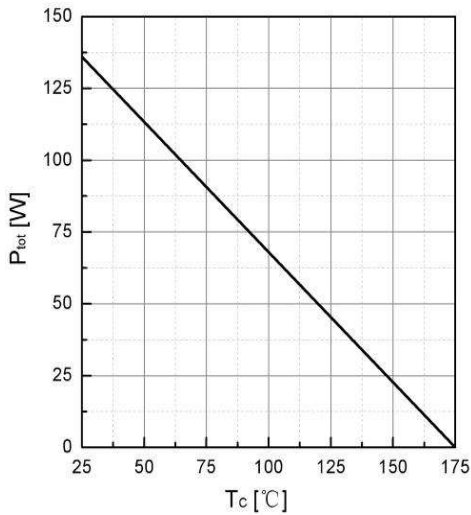


Fig 3. Power dissipation as a function of  $T_c$

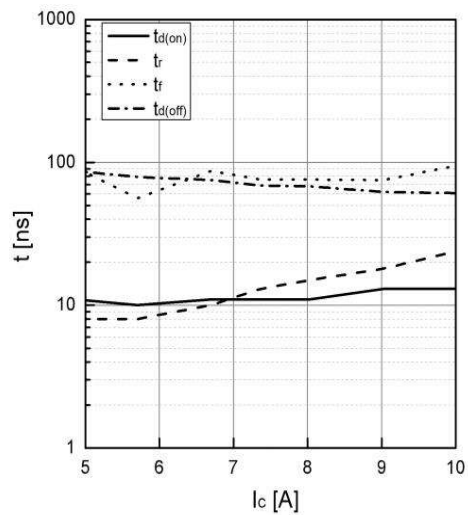


Fig 4. Typical switching time as a function of  $I_c$

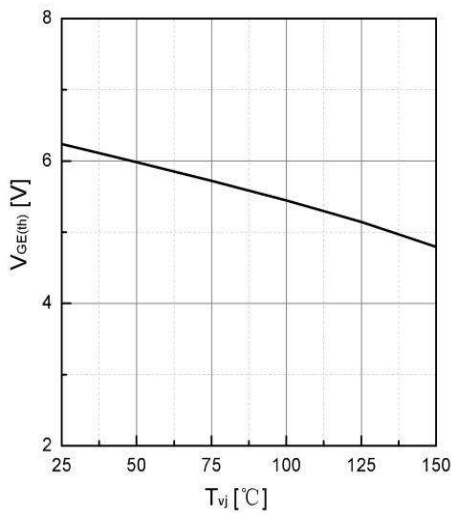


Fig 5. Typical  $V_{GE(th)}$  as a function of  $T_{vj}$  ( $I_c=1\text{mA}$ )

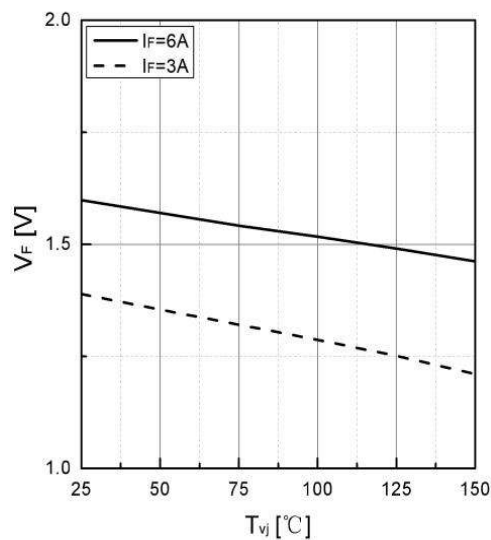


Fig 6. Typical  $V_F$  as a function of  $T_{vj}$

RATINGS AND CHARACTERISTIC CURVES

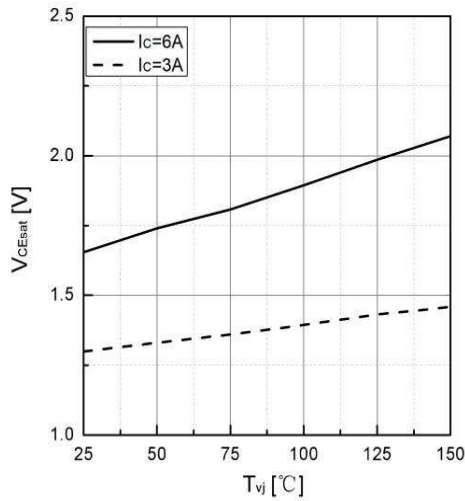


Fig 7. Typical  $V_{CEsat}$  as a function of  $T_{vj}$

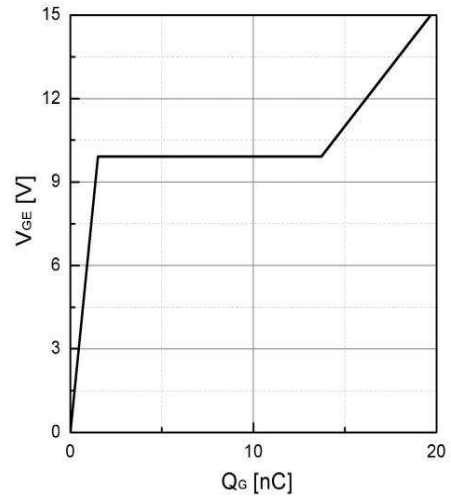


Fig 8. Typical Gate charge

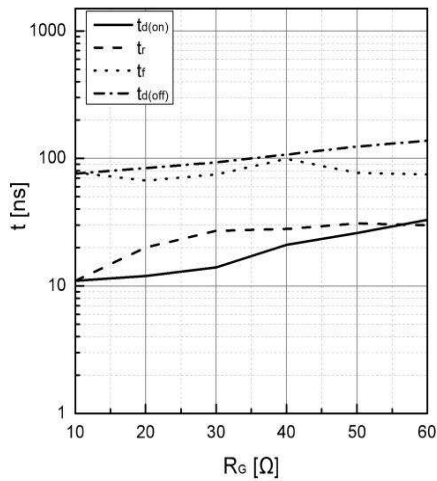


Fig 9. Typical switching times as a function of  $R_G$

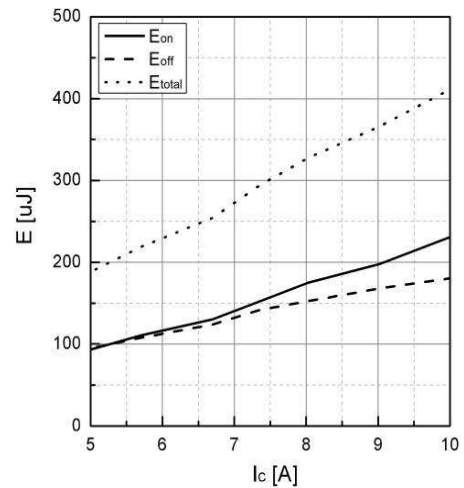


Fig 10. Typical switching energy losses as a function of  $I_C$

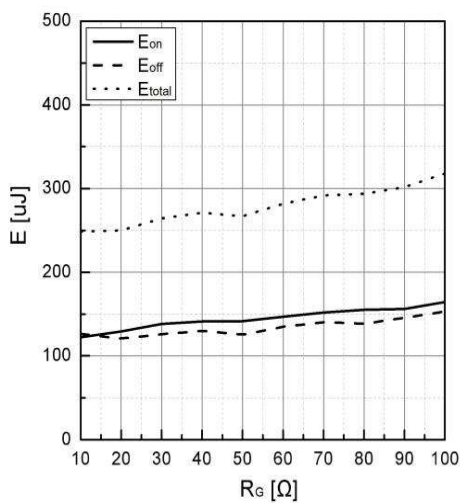


Fig 11. Typical switching energy losses as a function of  $R_G$

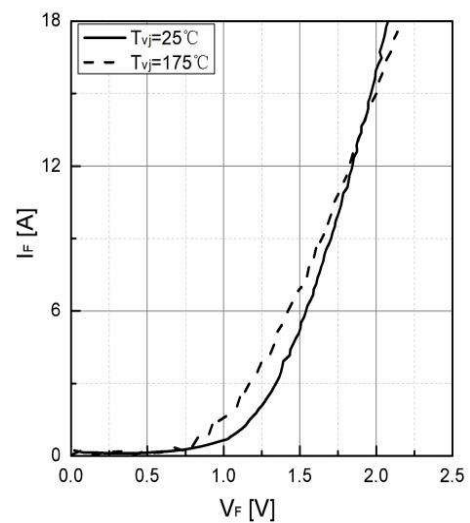


Fig 12. Typical  $I_F$  as a function of  $V_F$

RATINGS AND CHARACTERISTIC CURVES

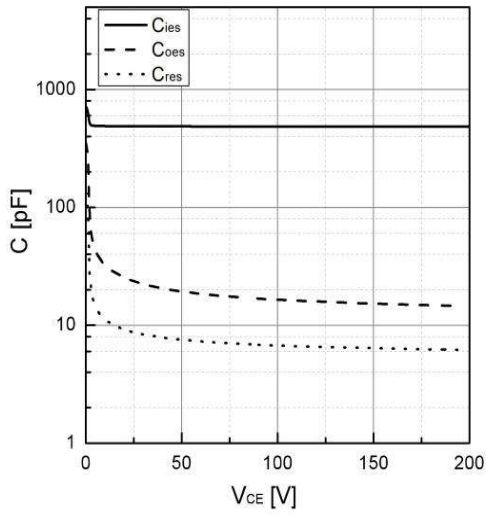


Fig 13. Typical capacitance as a function of  $V_{CE}$   
( $f=1\text{MHz}$ ,  $V_{GE}=0\text{V}$ )

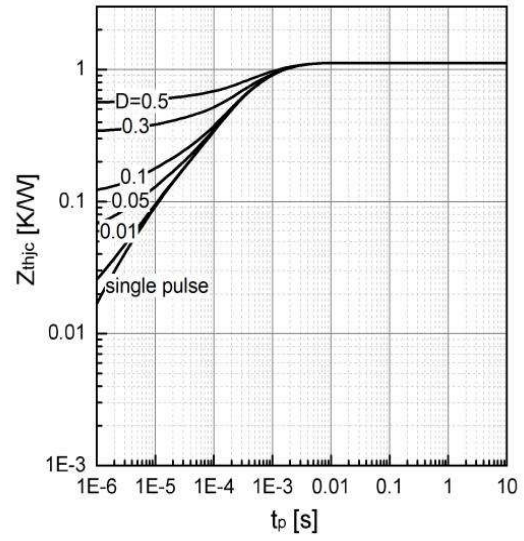
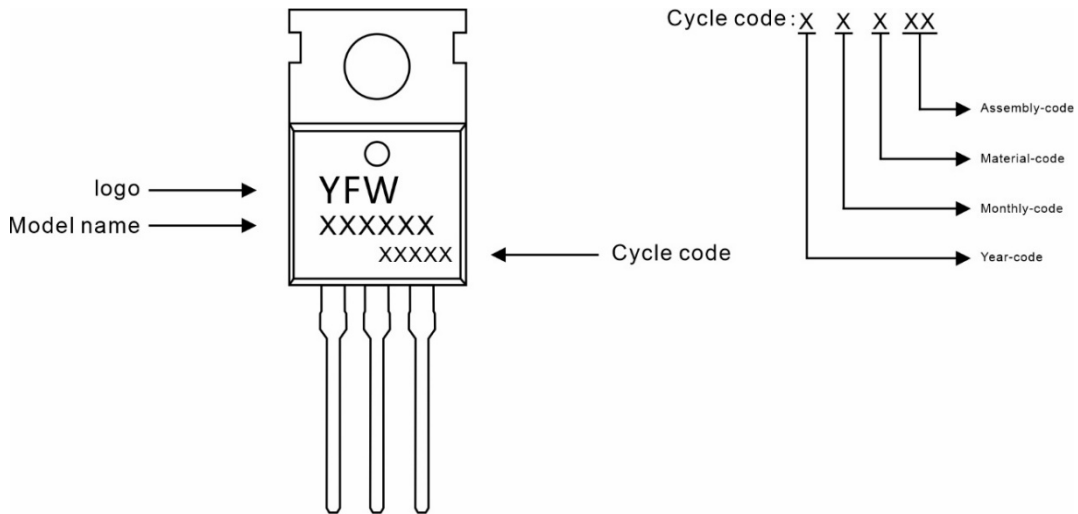


Fig 14. Transient thermal impedance of IGBT

**Marking Diagram**



**Ordering information**

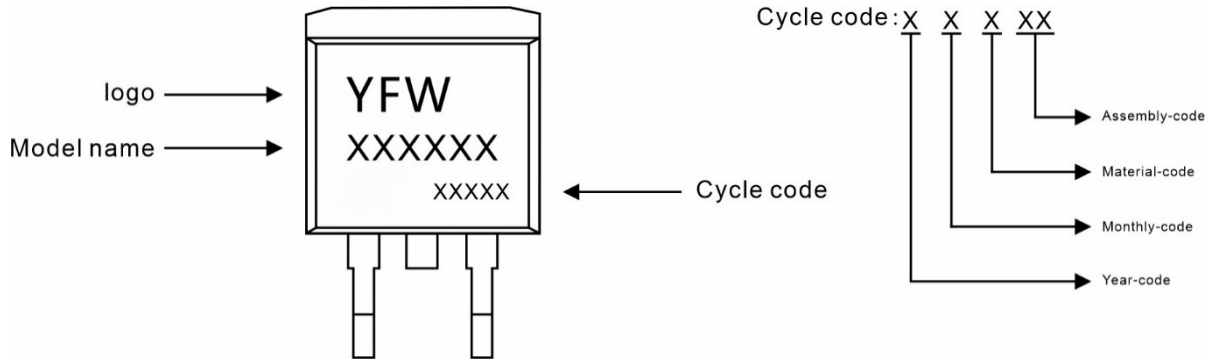
Model name	Package	Unit Weight	Base Quantity	Packing Quantity
YFWG06T65AC	TO-220C	0.07oz(1.96g)	50pcs/tube	1000PCS/Box 5000PCS/Carton

**Package Dimensions**

**TO-220C**

Dim	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.34	4.67	0.171	0.184
A1	2.52	2.82	0.099	0.111
b	0.71	0.91	0.028	0.036
b1	1.17	1.37	0.046	0.054
c	0.30	0.50	0.012	0.020
c1	1.17	1.37	0.046	0.054
D	9.90	10.20	0.390	0.402
E	8.50	8.90	0.335	0.350
E1	12.00	12.50	0.472	0.492
e	2.44	2.64	0.096	0.104
e1	4.88	5.28	0.192	0.208
F	2.60	2.80	0.102	0.110
L	13.20	13.80	0.520	0.543
L1	3.80	4.20	0.150	0.165
Φ	3.60	3.96	0.142	0.156

**Marking Diagram**



**Ordering information**

Model name	Package	Unit Weight	Base Quantity	Packing Quantity
YFWG06T65AS	TO-263	0.04oz(1.16g)	800pcs/reel	1600pcs/box 8000pcs/Carton

**Package Dimensions**

**TO-263**

Dim	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.30	4.70	0.169	0.185
A1	0.00	0.15	0.000	0.006
A2	4.30	4.55	0.169	0.179
B	1.10	1.50	0.043	0.059
b	0.70	0.90	0.028	0.035
b1	1.20	1.50	0.047	0.059
c	0.30	0.60	0.012	0.024
c1	1.17	1.37	0.046	0.054
D	9.90	10.20	0.390	0.402
E	8.50	8.90	0.335	0.350
e	2.44	2.64	0.096	0.104
e1	4.88	5.28	0.192	0.208
L	15.00	15.30	0.591	0.602
L1	5.20	5.40	0.205	0.213
L2	2.40	2.60	0.094	0.102
L3	1.60	1.80	0.063	0.071

## Disclaimer

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